

# BLC9H10XS-600A

Power LDMOS transistor

Rev. 1 — 10 August 2018

AMMPLION

Product data sheet

## 1. Product profile

### 1.1 General description

600 W LDMOS packaged asymmetric Doherty power transistor for base station applications at frequencies from 616 MHz to 960 MHz.

**Table 1. Typical performance 940 MHz**

Typical RF performance at  $T_{case} = 25\text{ °C}$  in an asymmetrical Doherty demo circuit.  $V_{DS} = 48\text{ V}$ ;  $I_{Dq} = 600\text{ mA}$  (main);  $V_{GS(amp)peak} = 0.48\text{ V}$ , unless otherwise specified.

| Test signal      | f          | $V_{DS}$ | $P_{L(AV)}$ | $G_p$ | $\eta_D$ | ACPR      |
|------------------|------------|----------|-------------|-------|----------|-----------|
|                  | (MHz)      | (V)      | (dBm)       | (dB)  | (%)      | (dBc)     |
| 1-carrier W-CDMA | 925 to 960 | 48       | 50.5        | 17.7  | 53.9     | -31.4 [1] |

[1] Test signal: 1-carrier W-CDMA; 3GPP test model 1; 64 DPCH; PAR = 9.6 dB at 0.01 % probability on CCDF.

**Table 2. Typical performance 880 MHz**

Typical RF performance at  $T_{case} = 25\text{ °C}$  in an asymmetrical Doherty demo circuit.  $V_{DS} = 50\text{ V}$ ;  $I_{Dq} = 600\text{ mA}$  (main);  $V_{GS(amp)peak} = 0.4\text{ V}$ , unless otherwise specified.

| Test signal      | f          | $V_{DS}$ | $P_{L(AV)}$ | $G_p$ | $\eta_D$ | ACPR      |
|------------------|------------|----------|-------------|-------|----------|-----------|
|                  | (MHz)      | (V)      | (dBm)       | (dB)  | (%)      | (dBc)     |
| 1-carrier W-CDMA | 869 to 894 | 50       | 50.5        | 18.3  | 52.7     | -30.8 [1] |

[1] Test signal: 1-carrier W-CDMA; 3GPP test model 1; 64 DPCH; PAR = 9.6 dB at 0.01 % probability on CCDF.

**Table 3. Typical performance 780 MHz**

Typical RF performance at  $T_{case} = 25\text{ °C}$  in an asymmetrical Doherty demo circuit.  $V_{DS} = 47\text{ V}$ ;  $I_{Dq} = 600\text{ mA}$  (main);  $V_{GS(amp)peak} = 0.5\text{ V}$ , unless otherwise specified.

| Test signal      | f          | $V_{DS}$ | $P_{L(AV)}$ | $G_p$ | $\eta_D$ | ACPR      |
|------------------|------------|----------|-------------|-------|----------|-----------|
|                  | (MHz)      | (V)      | (dBm)       | (dB)  | (%)      | (dBc)     |
| 1-carrier W-CDMA | 758 to 803 | 47       | 50.5        | 17.7  | 54.2     | -33.8 [1] |

[1] Test signal: 1-carrier W-CDMA; 3GPP test model 1; 64 DPCH; PAR = 9.6 dB at 0.01 % probability on CCDF.

**Table 4. Typical performance 750 MHz**

Typical RF performance at  $T_{case} = 25\text{ °C}$  in an asymmetrical Doherty demo circuit.  $V_{DS} = 48\text{ V}$ ;  $I_{Dq} = 600\text{ mA}$  (main);  $V_{GS(amp)peak} = 0.4\text{ V}$ , unless otherwise specified.

| Test signal      | f          | $V_{DS}$ | $P_{L(AV)}$ | $G_p$ | $\eta_D$ | ACPR      |
|------------------|------------|----------|-------------|-------|----------|-----------|
|                  | (MHz)      | (V)      | (dBm)       | (dB)  | (%)      | (dBc)     |
| 1-carrier W-CDMA | 729 to 768 | 48       | 50.5        | 17.5  | 57.2     | -30.8 [1] |

[1] Test signal: 1-carrier W-CDMA; 3GPP test model 1; 64 DPCH; PAR = 9.6 dB at 0.01 % probability on CCDF.

### 1.2 Features and benefits

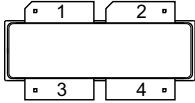
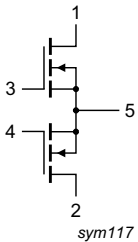
- Excellent ruggedness
- High efficiency
- Low thermal resistance providing excellent thermal stability
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent digital pre-distortion capability
- Internally matched for ease of use
- Integrated ESD protection
- For RoHS compliance see the product details on the Ampleon website

### 1.3 Applications

- RF power amplifiers for base stations and multi carrier applications in the 616 MHz to 960 MHz frequency range

## 2. Pinning information

Table 5. Pinning

| Pin | Description                | Simplified outline  | Graphic symbol   |
|-----|----------------------------|---|--|
| 1   | drain1                     |  |  |
| 2   | drain2                     |   |  |
| 3   | gate1                      |   |  |
| 4   | gate2                      |   |  |
| 5   | source <a href="#">[1]</a> |   |  |

[1] Connected to flange.

## 3. Ordering information

Table 6. Ordering information

| Type number    | Package |   |           |
|----------------|---------|---|-----------|
|                | Name    | Description                                     | Version   |
| BLC9H10XS-600A | -       | plastic earless flanged cavity package; 4 leads | SOT1250-2 |

## 4. Limiting values

Table 7. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol            | Parameter                          | Conditions | Min | Max | Unit |
|-------------------|------------------------------------|------------|-----|-----|------|
| $V_{DS}$          | drain-source voltage               |            | -   | 105 | V    |
| $V_{GS(amp)main}$ | main amplifier gate-source voltage |            | -6  | +11 | V    |
| $V_{GS(amp)peak}$ | peak amplifier gate-source voltage |            | -6  | +11 | V    |

**Table 7. Limiting values ...continued**  
*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol            | Parameter            | Conditions | Min | Max  | Unit |
|-------------------|----------------------|------------|-----|------|------|
| T <sub>stg</sub>  | storage temperature  |            | -65 | +150 | °C   |
| T <sub>j</sub>    | junction temperature | [1]        | -   | 225  | °C   |
| T <sub>case</sub> | case temperature     | [1]        | -40 | +125 | °C   |

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

## 5. Thermal characteristics

**Table 8. Thermal characteristics**

| Symbol               | Parameter                                | Conditions  | Typ   | Unit |
|----------------------|--|---|-------|------|
| R <sub>th(j-c)</sub> | thermal resistance from junction to case | V <sub>DS</sub> = 50 V; I <sub>Dq</sub> = 600 mA (main);<br>V <sub>GS(amp)peak</sub> = 0.5 V; T <sub>case</sub> = 80 °C |       |      |
|                      |  | P <sub>L</sub> = 112 W  | 0.236 | k/W  |
|                      |  | P <sub>L</sub> = 141 W  | 0.198 | k/W  |

## 6. Characteristics

**Table 9. DC characteristics**  
*T<sub>j</sub> = 25 °C unless otherwise specified.*

| Symbol               | Parameter                        | Conditions   | Min | Typ  | Max | Unit |
|----------------------|----------------------------------|--|-----|------|-----|------|
| <b>Main device</b>   |                                  |  |     |      |     |      |
| V <sub>(BR)DSS</sub> | drain-source breakdown voltage   | V <sub>GS</sub> = 0 V; I <sub>D</sub> = 1.0 mA                             | 105 | -    | -   | V    |
| V <sub>GS(th)</sub>  | gate-source threshold voltage    | V <sub>DS</sub> = 10 V; I <sub>D</sub> = 150 mA                            | 1.5 | 2.0  | 2.5 | V    |
| V <sub>GSq</sub>     | gate-source quiescent voltage    | V <sub>DS</sub> = 47 V; I <sub>D</sub> = 600 mA                            | -   | 2.2  | -   | V    |
| I <sub>DSS</sub>     | drain leakage current            | V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 50 V                              | -   | -    | 1.4 | µA   |
| I <sub>DSX</sub>     | drain cut-off current            | V <sub>GS</sub> = V <sub>GS(th)</sub> + 3.75 V;<br>V <sub>DS</sub> = 10 V  | -   | 24.5 | -   | A    |
| I <sub>GSS</sub>     | gate leakage current             | V <sub>GS</sub> = 11 V; V <sub>DS</sub> = 0 V                              | -   | -    | 140 | nA   |
| g <sub>fs</sub>      | forward transconductance         | V <sub>DS</sub> = 10 V; I <sub>D</sub> = 7.5 A                             | -   | 9.8  | -   | S    |
| R <sub>DS(on)</sub>  | drain-source on-state resistance | V <sub>GS</sub> = V <sub>GS(th)</sub> + 3.75 V;<br>I <sub>D</sub> = 5.25 A | -   | 160  | 203 | mΩ   |
| <b>Peak device</b>   |                                  |  |     |      |     |      |
| V <sub>(BR)DSS</sub> | drain-source breakdown voltage   | V <sub>GS</sub> = 0 V; I <sub>D</sub> = 2.2 mA                             | 105 | -    | -   | V    |
| V <sub>GS(th)</sub>  | gate-source threshold voltage    | V <sub>DS</sub> = 10 V; I <sub>D</sub> = 300 mA                            | 1.5 | 2.0  | 2.5 | V    |
| V <sub>GSq</sub>     | gate-source quiescent voltage    | V <sub>DS</sub> = 47 V; I <sub>D</sub> = 1200 mA                           | -   | 2.2  | -   | V    |
| I <sub>DSS</sub>     | drain leakage current            | V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 50 V                              | -   | -    | 2.8 | µA   |
| I <sub>DSX</sub>     | drain cut-off current            | V <sub>GS</sub> = V <sub>GS(th)</sub> + 3.75 V;<br>V <sub>DS</sub> = 10 V  | -   | 49.0 | -   | A    |
| I <sub>GSS</sub>     | gate leakage current             | V <sub>GS</sub> = 11 V; V <sub>DS</sub> = 0 V                              | -   | -    | 280 | nA   |
| g <sub>fs</sub>      | forward transconductance         | V <sub>DS</sub> = 10 V; I <sub>D</sub> = 15.0 A                            | -   | 19.6 | -   | S    |
| R <sub>DS(on)</sub>  | drain-source on-state resistance | V <sub>GS</sub> = V <sub>GS(th)</sub> + 3.75 V;<br>I <sub>D</sub> = 10.5 A | -   | 80   | 107 | mΩ   |

**Table 10. RF characteristics**

Test signal: 1-carrier W-CDMA; PAR = 9.6 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1 to 64 DPCH;  $f_1 = 760.5$  MHz;  $f_2 = 800.5$  MHz; RF performance at  $V_{DS} = 47$  V;  $I_{Dq} = 600$  mA (main);  $V_{GS(amp)peak} = 0.5$  V;  $T_{case} = 25$  °C; unless otherwise specified; in an asymmetrical Doherty production test circuit at frequencies from 758 MHz to 803 MHz.

| Symbol    | Parameter                    | Conditions          | Min  | Typ  | Max | Unit |
|-----------|------------------------------|---------------------|------|------|-----|------|
| $G_p$     | power gain                   | $P_{L(AV)} = 112$ W | 16.3 | 17.5 | -   | dB   |
| $RL_{in}$ | input return loss            | $P_{L(AV)} = 112$ W | -    | -16  | -10 | dB   |
| $\eta_D$  | drain efficiency             | $P_{L(AV)} = 112$ W | 48   | 53   | -   | %    |
| ACPR      | adjacent channel power ratio | $P_{L(AV)} = 112$ W | -    | -31  | -26 | dBc  |

**Table 11. RF characteristics**

Test signal: 1-carrier W-CDMA; PAR = 9.6 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 1 to 64 DPCH;  $f = 800.5$  MHz; RF performance at  $V_{DS} = 47$  V;  $I_{Dq} = 600$  mA (main);  $V_{GS(amp)peak} = 0.5$  V;  $T_{case} = 25$  °C; unless otherwise specified; in an asymmetrical Doherty production test circuit at frequencies from 758 MHz to 803 MHz.

| Symbol     | Parameter                    | Conditions          | Min | Typ | Max | Unit |
|------------|------------------------------|---------------------|-----|-----|-----|------|
| $PAR_O$    | output peak-to-average ratio | $P_{L(AV)} = 155$ W | 6.4 | 6.9 | -   | dB   |
| $P_{L(M)}$ | peak output power            | $P_{L(AV)} = 155$ W | 663 | 765 | -   | W    |

## 7. Test information

### 7.1 Ruggedness in Doherty operation

The BLC9H10XS-600A is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS} = 52$  V;  $I_{Dq} = 600$  mA;  $V_{GS(amp)peak} = 0.48$  V;  $f = 758$  MHz;  $P_L = 189$  W (5 dB OBO); pulsed CW ( $t_p = 100$   $\mu$ s;  $\delta = 10$  %).

### 7.2 Impedance information

**Table 12. Typical impedance of main device**

Measured load-pull data of main device;  $I_{Dq} = 750$  mA (main);  $V_{DS} = 50$  V; pulsed CW ( $t_p = 100$   $\mu$ s;  $\delta = 10$  %).

| f                         | $Z_S$ [1]    | $Z_L$ [1]    | $P_L$ [2] | $\eta_D$ [2] | $G_p$ [2] |
|---------------------------|--------------|--------------|-----------|--------------|-----------|
| (MHz)                     | ( $\Omega$ ) | ( $\Omega$ ) | (W)       | (%)          | (dB)      |
| <b>Maximum power load</b> |              |              |           |              |           |
| 600                       | 6.5 – j2.3   | 2.6 + j0.1   | 354.1     | 66.7         | 18.8      |
| 698                       | 4.1 – j2.5   | 2.1 + j0.4   | 314.3     | 59.7         | 19.4      |
| 720                       | 3.9 – j2.9   | 2.1 + j0.3   | 302.9     | 58.5         | 19.4      |
| 746                       | 3.7 – j3.3   | 2.1 + j0.3   | 346.9     | 66.0         | 19.5      |
| 757                       | 3.7 – j3.6   | 2.1 + j0.0   | 358.3     | 68.8         | 19.1      |
| 769                       | 3.6 – j3.8   | 2.2 + j0.1   | 363.3     | 69.7         | 19.6      |
| 790                       | 3.7 – j4.2   | 1.9 + j0.2   | 357.5     | 68.9         | 19.6      |
| 805                       | 3.8 – j4.5   | 1.9 + j0.1   | 347.1     | 65.1         | 19.3      |
| 820                       | 3.8 – j4.7   | 2.0 + j0.2   | 364.4     | 70.4         | 19.8      |
| 869                       | 4.4 – j5.7   | 1.8 – j0.1   | 365.9     | 69.3         | 19.3      |

**Table 12. Typical impedance of main device ...continued**

Measured load-pull data of main device;  $I_{Dq} = 750 \text{ mA (main)}$ ;  $V_{DS} = 50 \text{ V}$ ; pulsed CW ( $t_p = 100 \mu\text{s}$ ;  $\delta = 10 \%$ ).

| f<br>(MHz)                           | $Z_S$ [1]<br>( $\Omega$ ) | $Z_L$ [1]<br>( $\Omega$ ) | $P_L$ [2]<br>(W) | $\eta_D$ [2]<br>(%) | $G_p$ [2]<br>(dB) |
|--------------------------------------|---------------------------|---------------------------|------------------|---------------------|-------------------|
| 880                                  | 4.5 – j5.9                | 1.9 + j0.0                | 361.4            | 72.8                | 19.9              |
| 894                                  | 4.8 – j6.2                | 2.1 – j0.1                | 356.3            | 72.2                | 20.0              |
| 925                                  | 5.7 – j6.8                | 1.9 – j0.6                | 349.6            | 64.0                | 18.8              |
| 960                                  | 7.1 – j7.0                | 1.6 – j0.4                | 350.0            | 67.4                | 19.0              |
| 1000                                 | 8.9 – j6.6                | 1.9 – j0.2                | 336.1            | 71.3                | 19.5              |
| <b>Maximum drain efficiency load</b> |                           |                           |                  |                     |                   |
| 600                                  | 6.4 – j2.0                | 2.5 + j1.9                | 239.5            | 79.6                | 21.0              |
| 698                                  | 4.1 – j2.3                | 2.0 + j1.4                | 253.3            | 65.9                | 20.8              |
| 720                                  | 3.7 – j2.7                | 1.8 + j1.7                | 227.9            | 72.5                | 21.2              |
| 746                                  | 3.6 – j3.2                | 1.9 + j1.4                | 248.0            | 78.6                | 21.0              |
| 757                                  | 3.5 – j3.4                | 1.9 + j1.4                | 243.3            | 78.7                | 21.0              |
| 769                                  | 3.5 – j3.7                | 2.1 + j0.9                | 282.8            | 79.6                | 20.8              |
| 790                                  | 3.5 – j4.1                | 2.4 + j1.8                | 218.6            | 80.6                | 22.2              |
| 805                                  | 3.7 – j4.3                | 2.0 + j1.8                | 232.0            | 76.0                | 22.3              |
| 820                                  | 3.6 – j4.6                | 2.1 + j1.2                | 289.5            | 78.8                | 21.7              |
| 869                                  | 4.1 – j5.3                | 1.6 + j1.5                | 218.5            | 80.0                | 22.6              |
| 880                                  | 4.3 – j5.6                | 1.6 + j1.3                | 224.5            | 79.7                | 22.8              |
| 894                                  | 4.5 – j5.9                | 1.5 + j1.1                | 247.5            | 79.4                | 22.0              |
| 925                                  | 5.3 – j6.4                | 1.7 + j1.2                | 221.6            | 79.8                | 22.5              |
| 960                                  | 6.6 – j6.5                | 1.1 + j1.0                | 186.1            | 78.8                | 22.6              |
| 1000                                 | 8.6 – j6.0                | 1.2 + j0.7                | 214.8            | 77.3                | 21.9              |

[1]  $Z_S$  and  $Z_L$  defined in Figure 1.

[2] At 3 dB gain compression.

**Table 13. Typical impedance of peak device**

Measured load-pull data of peak device;  $I_{Dq} = 1400 \text{ mA (peak)}$ ;  $V_{DS} = 50 \text{ V}$ ; pulsed CW ( $t_p = 100 \mu\text{s}$ ;  $\delta = 10 \%$ ).

| f<br>(MHz)                | $Z_S$ [1]<br>( $\Omega$ ) | $Z_L$ [1]<br>( $\Omega$ ) | $P_L$ [2]<br>(W) | $\eta_D$ [2]<br>(%) | $G_p$ [2]<br>(dB) |
|---------------------------|---------------------------|---------------------------|------------------|---------------------|-------------------|
| <b>Maximum power load</b> |                           |                           |                  |                     |                   |
| 600                       | 3.3 – j1.3                | 1.2 + j0.0                | 682.7            | 67.7                | 18.2              |
| 698                       | 2.1 – j1.4                | 1.2 + j0.1                | 693.3            | 69.7                | 19.2              |
| 720                       | 2.1 – j1.6                | 1.1 + j0.1                | 696.9            | 69.8                | 19.2              |
| 746                       | 2.0 – j1.8                | 1.2 + j0.0                | 688.2            | 68.2                | 19.1              |
| 757                       | 2.0 – j1.8                | 1.2 + j0.0                | 680.6            | 70.3                | 19.3              |
| 769                       | 1.8 – j1.9                | 1.2 + j0.0                | 673.6            | 70.5                | 19.8              |
| 790                       | 1.9 – j2.2                | 1.0 + j0.0                | 665.5            | 69.6                | 19.7              |
| 805                       | 2.0 – j2.4                | 0.9 + j0.0                | 670.5            | 70.3                | 19.3              |
| 820                       | 1.9 – j2.4                | 0.9 + j0.0                | 688.1            | 71.5                | 19.5              |

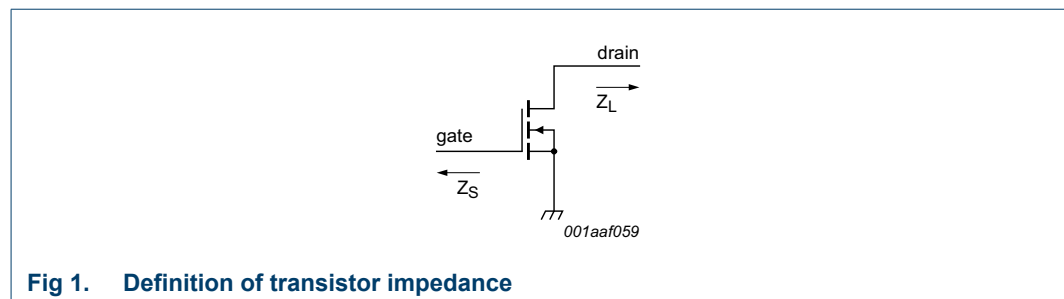
**Table 13. Typical impedance of peak device ...continued**

Measured load-pull data of peak device;  $I_{DQ} = 1400 \text{ mA (peak)}$ ;  $V_{DS} = 50 \text{ V}$ ; pulsed CW ( $t_p = 100 \mu\text{s}$ ;  $\delta = 10 \%$ ).

| f                                    | $Z_S$ [1]    | $Z_L$ [1]    | $P_L$ [2] | $\eta_D$ [2] | $G_p$ [2] |
|--------------------------------------|--------------|--------------|-----------|--------------|-----------|
| (MHz)                                | ( $\Omega$ ) | ( $\Omega$ ) | (W)       | (%)          | (dB)      |
| 869                                  | 2.2 – j2.7   | 1.1 – j0.5   | 670.7     | 64.0         | 18.8      |
| 880                                  | 2.2 – j2.8   | 1.1 – j0.5   | 668.4     | 65.3         | 19.1      |
| 894                                  | 2.3 – j3.0   | 1.1 – j0.5   | 671.2     | 66.8         | 19.2      |
| 925                                  | 2.7 – j3.1   | 1.0 – j0.4   | 664.5     | 68.6         | 19.4      |
| 960                                  | 3.3 – j3.2   | 1.0 – j0.4   | 648.7     | 69.2         | 19.5      |
| 1000                                 | 4.0 – j2.9   | 1.0 – j0.5   | 623.2     | 67.2         | 19.5      |
| <b>Maximum drain efficiency load</b> |              |              |           |              |           |
| 600                                  | 3.2 – j1.2   | 1.2 + j1.1   | 439.5     | 81.3         | 20.8      |
| 698                                  | 2.1 – j1.4   | 1.1 + j1.2   | 403.3     | 80.6         | 22.1      |
| 720                                  | 2.0 – j1.5   | 1.1 + j1.2   | 408.6     | 81.5         | 22.1      |
| 746                                  | 1.9 – j1.7   | 1.1 + j1.0   | 439.3     | 80.7         | 21.8      |
| 757                                  | 1.9 – j1.9   | 1.1 + j0.9   | 452.9     | 79.7         | 21.7      |
| 769                                  | 1.9 – j2.0   | 0.9 + j1.0   | 397.5     | 80.0         | 22.6      |
| 790                                  | 1.8 – j2.2   | 0.9 + j0.9   | 408.1     | 78.2         | 22.5      |
| 805                                  | 1.9 – j2.1   | 0.9 + j0.6   | 485.2     | 79.6         | 21.2      |
| 820                                  | 1.8 – j2.2   | 0.8 + j0.8   | 387.7     | 82.8         | 22.7      |
| 869                                  | 2.0 – j2.5   | 0.7 + j0.6   | 374.6     | 83.1         | 22.5      |
| 880                                  | 1.9 – j2.5   | 0.7 + j0.6   | 351.5     | 82.5         | 23.2      |
| 894                                  | 2.0 – j2.7   | 0.7 + j0.4   | 378.6     | 82.9         | 22.7      |
| 925                                  | 1.9 – j2.8   | 0.7 + j0.4   | 365.8     | 81.5         | 23.0      |
| 960                                  | 2.5 – j2.9   | 0.7 + j0.2   | 395.0     | 79.3         | 22.6      |
| 1000                                 | 3.0 – j2.8   | 0.7 + j0.3   | 361.3     | 76.0         | 23.2      |

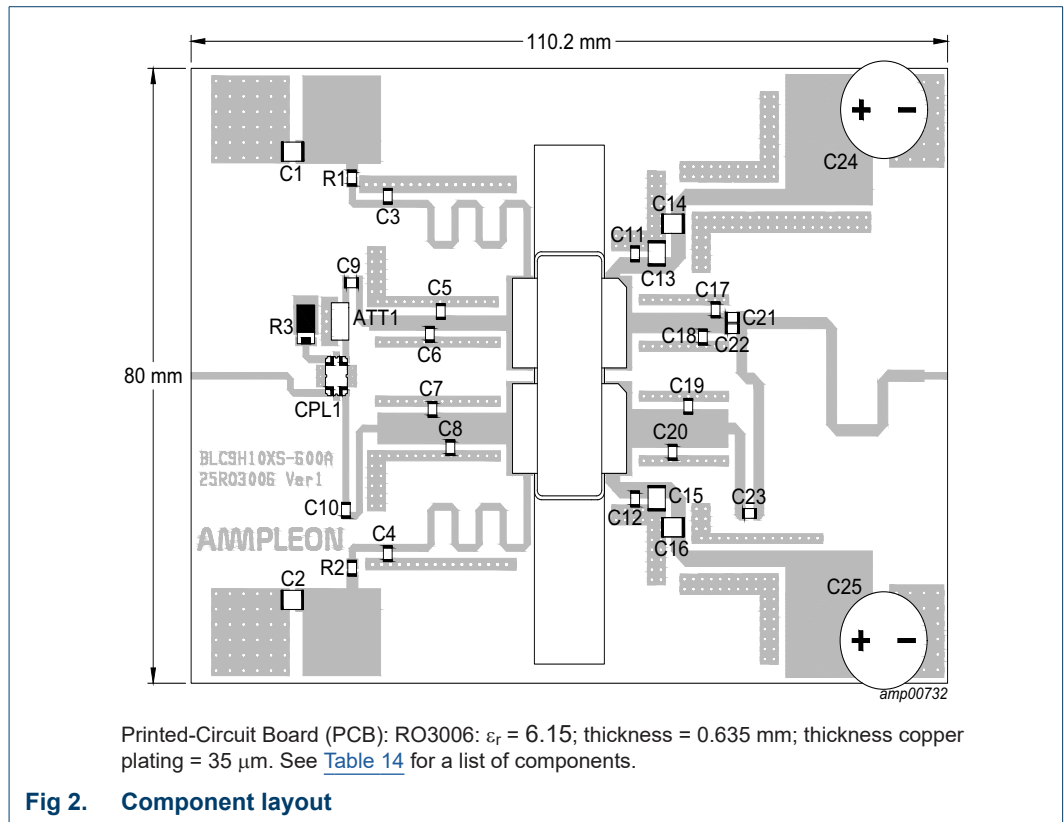
[1]  $Z_S$  and  $Z_L$  defined in Figure 1.

[2] At 3 dB gain compression.



**Fig 1. Definition of transistor impedance**

7.3 Test circuit



**Table 14. List of components**

See [Figure 2](#) for component layout.

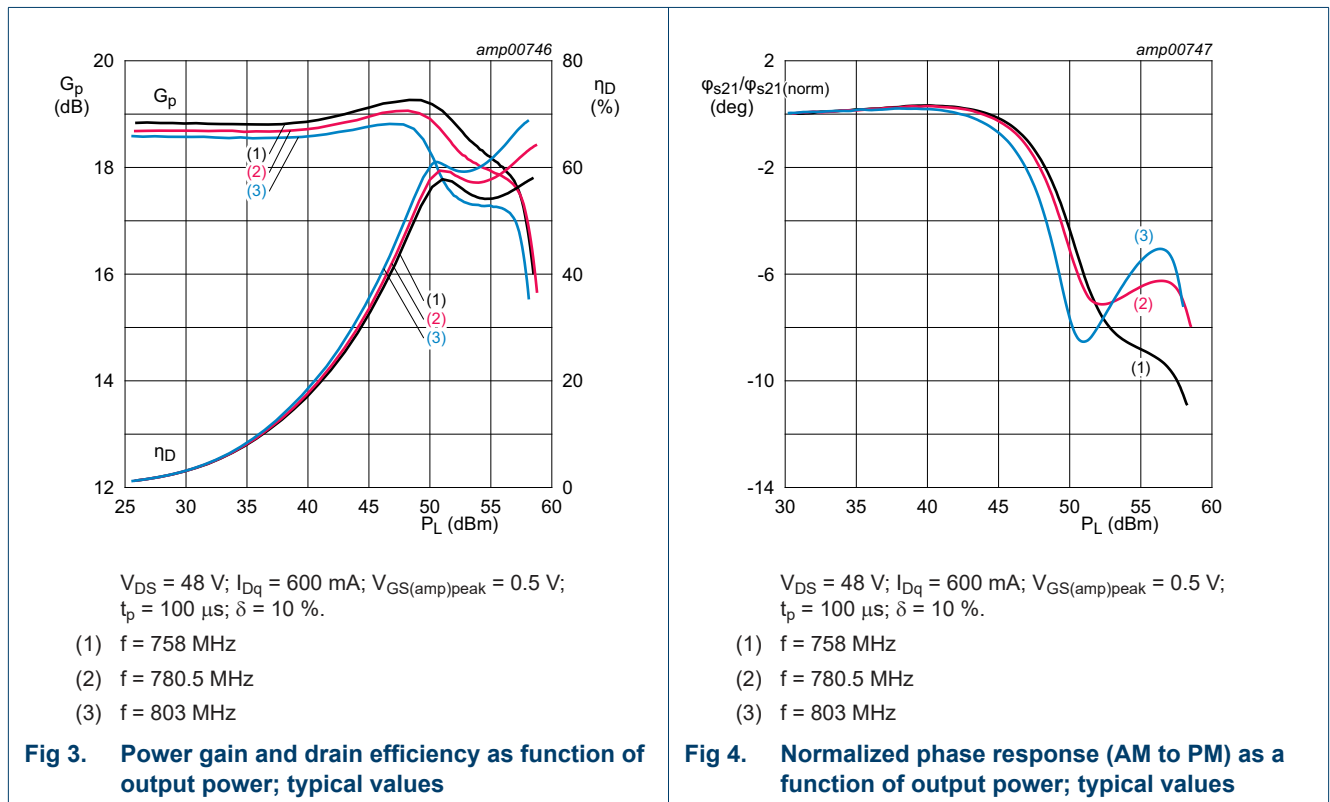
| Component                      | Description                       | Value                     | Remarks  |
|--------------------------------|-----------------------------------|---------------------------|--|
| C1, C2                         | multilayer ceramic chip capacitor | 4.7 $\mu\text{F}$ , 50 V  | Murata: Hi-Q SMD 1210, GRM32ER71H475KA88L      |
| C3, C4, C9, C10, C11, C12, C23 | multilayer ceramic chip capacitor | 68 pF                     | Murata: Hi-Q SMD 0805                          |
| C5                             | multilayer ceramic chip capacitor | 8.2 pF                    | Murata: Hi-Q SMD 0805                          |
| C6                             | multilayer ceramic chip capacitor | 3.9 pF                    | Murata: Hi-Q SMD 0805                          |
| C7                             | multilayer ceramic chip capacitor | 8.2 pF                    | Murata: Hi-Q SMD 0805                          |
| C8                             | multilayer ceramic chip capacitor | 7.5 pF                    | Murata: Hi-Q SMD 0805                          |
| C13, C14, C15, C16             | multilayer ceramic chip capacitor | 4.7 $\mu\text{F}$ , 100 V | Murata: Hi-Q SMD 1210, GRM42-256X7S475K100H530 |
| C17                            | multilayer ceramic chip capacitor | 9.1 pF                    | Murata: Hi-Q SMD 0805                          |
| C18                            | multilayer ceramic chip capacitor | 2 pF                      | Murata: Hi-Q SMD 0805                          |
| C19                            | multilayer ceramic chip capacitor | 12 pF                     | Murata: Hi-Q SMD 0805                          |
| C20                            | multilayer ceramic chip capacitor | 12 pF                     | Murata: Hi-Q SMD 0805                          |
| C21, C22                       | multilayer ceramic chip capacitor | 8.2 pF                    | Murata: Hi-Q SMD 0805                          |
| C24, C25                       | electrolytic capacitor            | 470 $\mu\text{F}$ , 63 V  |  |
| R1, R2                         | resistor                          | 4.7 $\Omega$ , 1 %        | SMD 0805                                       |

Table 14. List of components ...continued  
See Figure 2 for component layout.

| Component | Description    | Value      | Remarks             |
|-----------|----------------|------------|---------------------|
| R3        | resistor       | 50 Ω, 25 W | Anaren: C16A50Z4    |
| ATT1      | attenuator     | 1 dB, 10 W | Anaren: D10AA1Z4    |
| CPL1      | hybrid coupler | 2 dB; 90°  | Anaren: X3C07F1-02S |

## 7.4 Graphical data

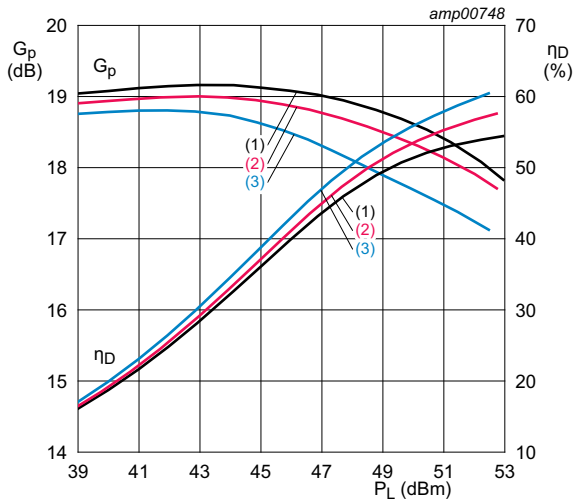
### 7.4.1 Pulsed CW





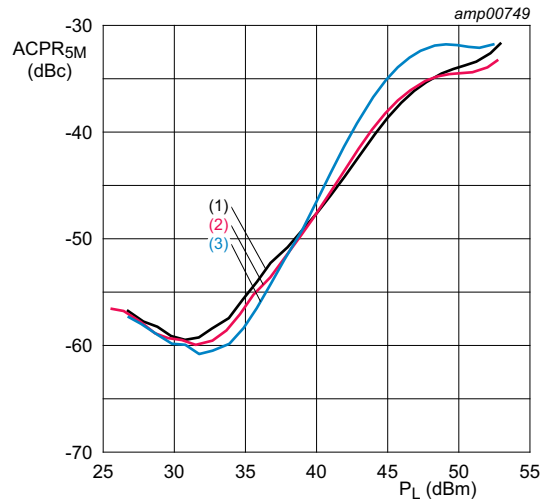
7.4.2 1-Carrier W-CDMA

Test signal: 3GPP test model 1; 1 to 64 DPCH (100 % clipping); PAR = 9.9 dB per carrier at 0.01 % probability on CCDF per carrier.



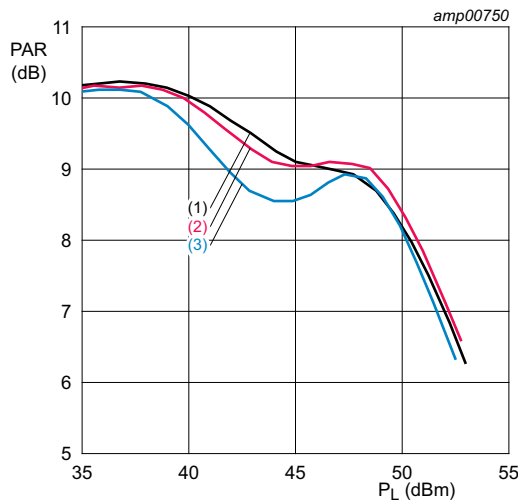
$V_{DS} = 48 \text{ V}; I_{Dq} = 600 \text{ mA}; V_{GS(amp)peak} = 0.5 \text{ V}.$   
 (1)  $f = 758 \text{ MHz}$   
 (2)  $f = 780.5 \text{ MHz}$   
 (3)  $f = 803 \text{ MHz}$

Fig 5. Power gain and drain efficiency as function of output power; typical values



$V_{DS} = 48 \text{ V}; I_{Dq} = 600 \text{ mA}; V_{GS(amp)peak} = 0.5 \text{ V}.$   
 (1)  $f = 758 \text{ MHz}$   
 (2)  $f = 780.5 \text{ MHz}$   
 (3)  $f = 803 \text{ MHz}$

Fig 6. Adjacent channel power ratio (5 MHz) as a function of output power; typical values

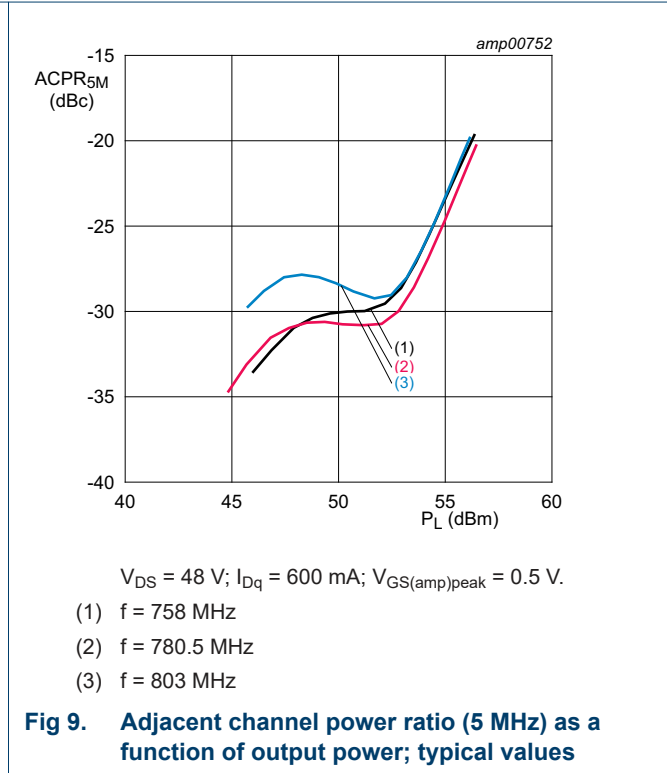
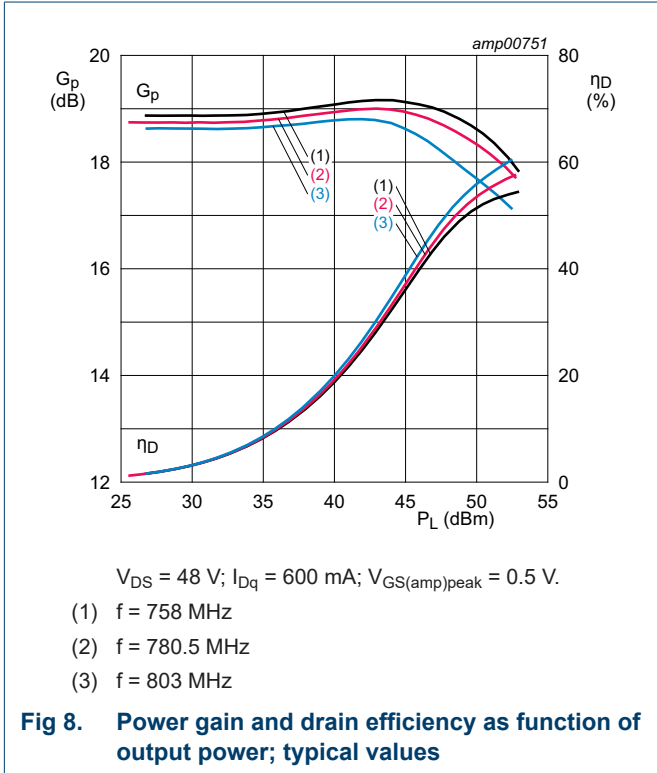


$V_{DS} = 48 \text{ V}; I_{Dq} = 600 \text{ mA}; V_{GS(amp)peak} = 0.5 \text{ V}.$   
 (1)  $f = 758 \text{ MHz}$   
 (2)  $f = 780.5 \text{ MHz}$   
 (3)  $f = 803 \text{ MHz}$

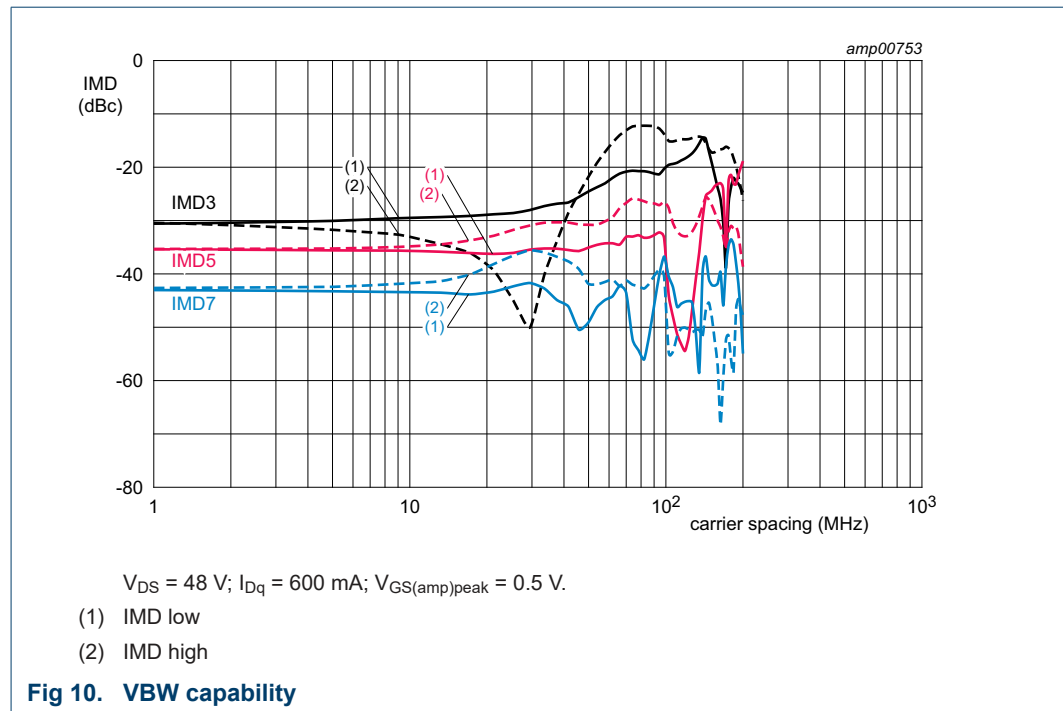
Fig 7. Peak-to-average power ratio as a function of output power; typical values

7.4.3 2-Carrier W-CDMA

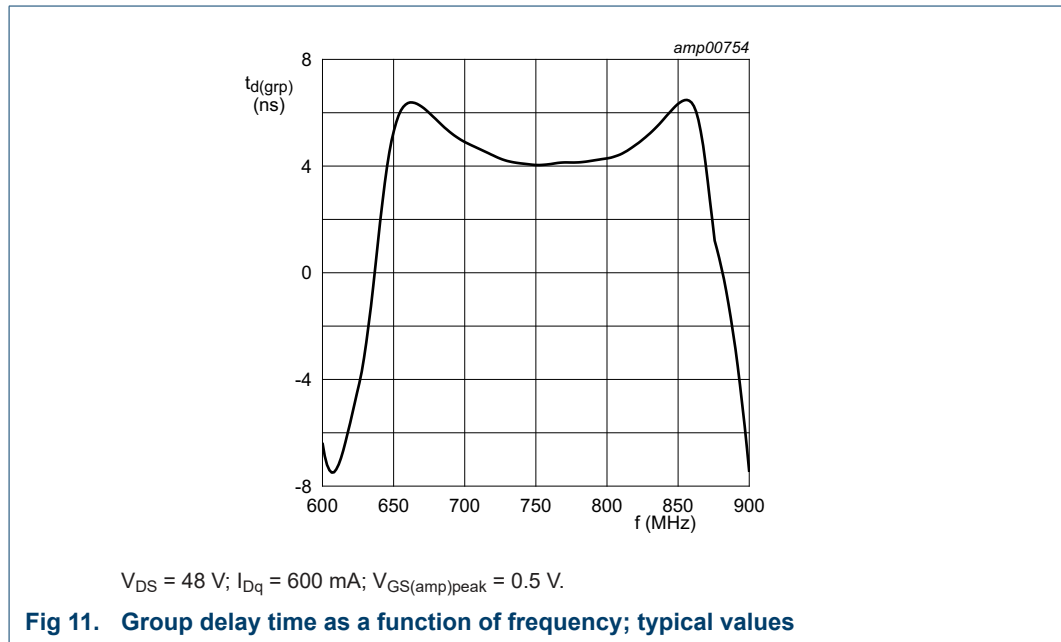
Test signal: 3GPP test model 1; 1 to 64 DPCH (46 % clipping); PAR = 9.9 dB per carrier at 0.01 % probability on CCDF per carrier.



7.4.4 2-Tone VBW



7.4.5 Group delay



### 8. Package outline

Plastic earless flanged cavity package; 4 leads

SOT1250-2

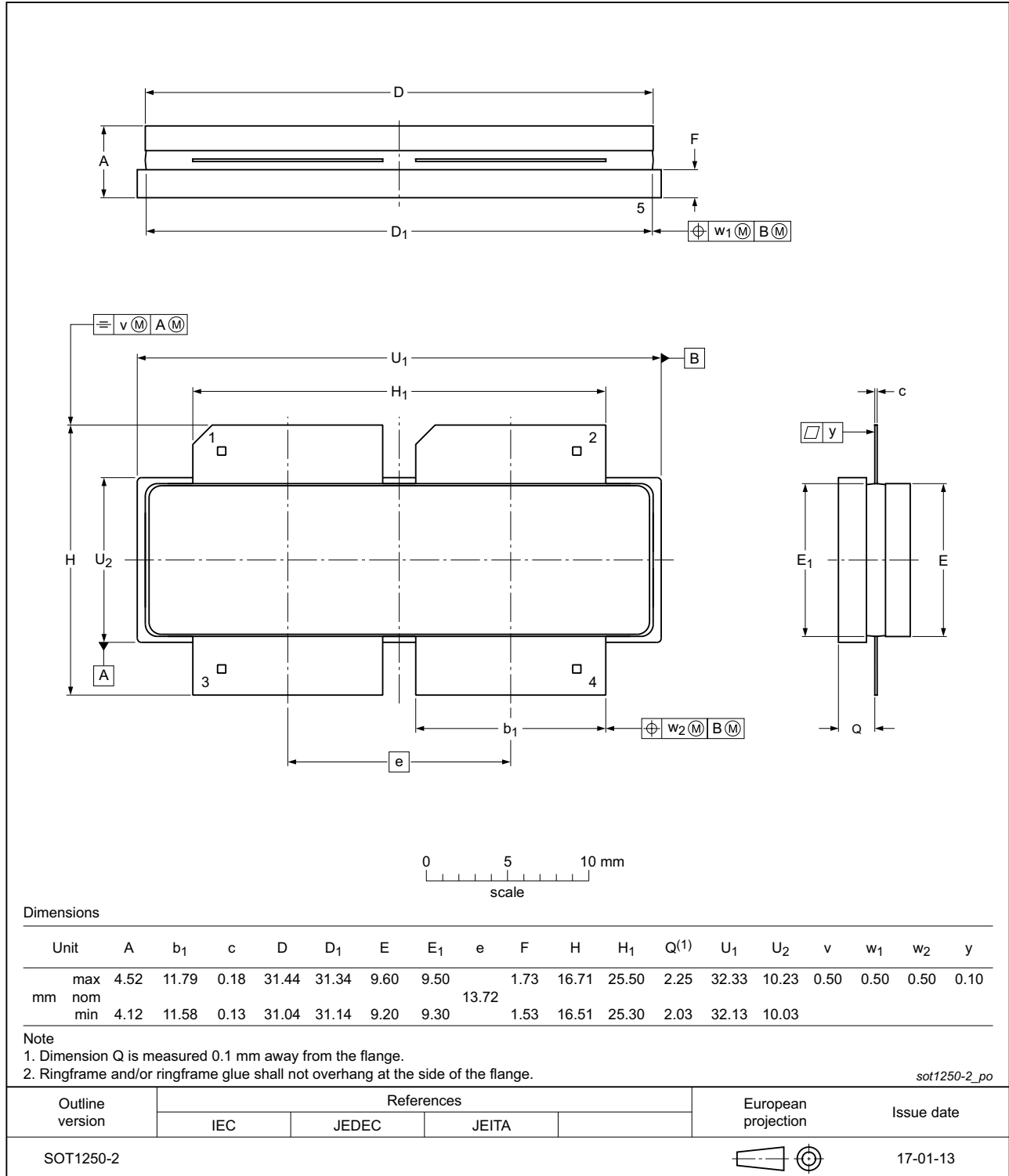



Fig 12. Package outline SOT1250-2

## 9. Handling information

| CAUTION   |   |
|---|---|
|  | <p>This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.</p> <p>Such precautions are described in the <i>ANSI/ESD S20.20</i>, <i>IEC/ST 61340-5</i>, <i>JESD625-A</i> or equivalent standards.</p> |

**Table 15. ESD sensitivity**

| ESD model  | Class                  |
|--|------------------------|
| Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002 | C3 <a href="#">[1]</a> |
| Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001     | 2 <a href="#">[2]</a>  |

[1] CDM classification C3 is granted to any part that passes after exposure to an ESD pulse of  $\geq 1000$  V.

[2] HBM classification 2 is granted to any part that passes after exposure to an ESD pulse of 2000 V.

## 10. Abbreviations

**Table 16. Abbreviations**

| Acronym | Description                                    |
|---------|--|
| 3GPP    | 3rd Generation Partnership Project             |
| AM      | Amplitude Modulation                           |
| CCDF    | Complementary Cumulative Distribution Function |
| CW      | Continuous Wave                                |
| DPCH    | Dedicated Physical CHannel                     |
| ESD     | ElectroStatic Discharge                        |
| IMD     | InterModulation Distortion                     |
| LDMOS   | Laterally Diffused Metal-Oxide Semiconductor   |
| MTF     | Median Time to Failure                         |
| OBO     | Output Back Off                                |
| PM      | Phase Modulation                               |
| PAR     | Peak-to-Average Ratio                          |
| RoHS    | Restriction of Hazardous Substances            |
| SMD     | Surface Mounted Device                         |
| VBW     | Video BandWidth                                |
| VSWR    | Voltage Standing Wave Ratio                    |
| W-CDMA  | Wideband Code Division Multiple Access         |

## 11. Revision history

**Table 17. Revision history**

| Document ID        | Release date | Data sheet status  | Change notice | Supersedes |
|--------------------|--------------|--------------------|---------------|------------|
| BLC9H10XS-600A v.1 | 20180810     | Product data sheet | -             | -          |

## 12. Legal information

### 12.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.ampleon.com>.

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